

Comparing Spansion® S34ML04G100 with Macronix MX30LF4G18AC

1. Introduction

This application note is a guide for migrating to the Macronix MX30LF4G18AC from the Spansion® S34ML04G100 4Gb, 3V, NAND flash memory.

The document does not provide detailed information on the individual devices, but highlights the major similarities and differences between them. The comparison covers the general features, performance, command codes and other differences.

The information in this document is based on datasheets listed in Section 10. Newer versions of the datasheets may override the contents of this document.

2. Features

Both flash device families have similar features and functions as shown in Table 2-1.

Table 2-1: Feature Comparison

Feature	Macronix MX30LF4G18AC	Spansion S34ML04G100
Vcc voltage range	2.7V ~ 3.6V	2.7V ~ 3.6V
Bus Width	x8	x8
Operating Temperature	-40°C ~ 85°C	-40°C ~ 85°C
Interface	ONFI 1.0 Standard	ONFI 1.0 Standard
Block Size	128KB+4KB	128KB+4KB
Page Size	2KB+64B	2KB+64B
ECC Requirement	4b /528B	1b /528B
OTP Size	30 pages	64 pages
Guarantee Good Blocks at Shipping	Block 0	Block 0, 1
Unique ID	ONFI standard	ONFI standard
ID Code	C2h /DCh/90h/95h/ 56h	01h /DCh/90h/95h/ 54h
ONFI Signature	4Fh/4Eh/46h/49h	4Fh/4Eh/46h/49h
Data Retention	10 Years	10 Years
Package	48-TSOP (12x20mm) 63-VFBGA (9x11mm)	48-TSOP (12x20mm) 63-VFBGA (9x11mm)

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3. Performance

Table 3-1 and Table 3-2 show MX30LF4G18AC and S34ML04G100 Read/Write performance.

Table 3-1: Read Function Performance (Read Latency time and Sequential Read)

Read function	Macronix MX30LF4G18AC	Spansion S34ML04G100
Read Latency time (tR)	25us (max.)	25us (max.)
Sequential Read time (tRC)	20ns (min.)	25ns (min.)

Table 3-2: Write Function Performance (Program and Erase)

Write Function	Macronix MX30LF4G18AC	Spansion S34ML04G100
Page Program time (tPROG)	300us (typ.) / 600us (max.)	200us (typ.) / 700us (max.)
Block Erase time (tERASE)	1ms (typ.) / 3.5ms (max.)	3.5ms (typ.) / 10ms (max.)
NOP	4 (max.)	4 (max.)
Write/Erase Cycles* ¹ (Endurance)	100,000	100,000

Note: 100K Endurance cycle with ECC protection.

4. DC Characteristics

Read/Write power requirements (Table 4-1) and I/O voltage limits (Table 4-2) are similar.

Table 4-1: Read / Write Current

DC Characteristic	Macronix MX30LF4G18AC	Spansion S34ML04G100
Sequential Read Current (ICC1)	20mA (typ.) / 30mA (max.)	15mA (typ.) / 30mA (max.)
Program Current (ICC2)	20mA (typ.) / 30mA (max.)	NA (typ.) / 30mA (max.)
Erase Current (ICC3)	15mA (typ.) / 30mA (max.)	15mA (typ.) / 30mA (max.)
Standby Current – CMOS	10uA (typ.) / 50uA (max.)	10uA (typ.) / 50uA (max.)

Table 4-2: Input / Output Voltage

DC Characteristic	Macronix MX30LF4G18AC	Spansion S34ML04G100
Input Low Voltage (VIL)	-0.3V (min.) / 0.2VCC (max.)	-0.3V (min.) / 0.2Vcc (max.)
Input High Voltage (VIH)	0.8VCC (min.) / VCC+0.3V (max.)	0.8Vcc (min.) / Vcc+0.3V (max.)
Output Low Voltage (VOL)	0.2V (max.)	0.4V (max.)
Output High Voltage (VOH)	VCC-0.2 (min.)	2.4V (min.)

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5. Package Pin/Ball Definition

Package physical dimensions are similar to each other. For detailed information, please refer to the individual datasheets. Tables 5-1 and 5-2 show differences in pin assignments between the Macronix and Spansion devices. S34ML04G100 can be compared by the MX30LF4G18AC without pin conflicts. Only 48-TSOP pin #38 (ball G5 on VFBGA) may need special attention because the pin is designated “PT” which is chip protected function on the MX30LF4G18AC-TI, but S34ML04G100 is designated as NC.

Figure 5-1: 48-TSOP (12x20mm) Package and Pin Layout Comparison

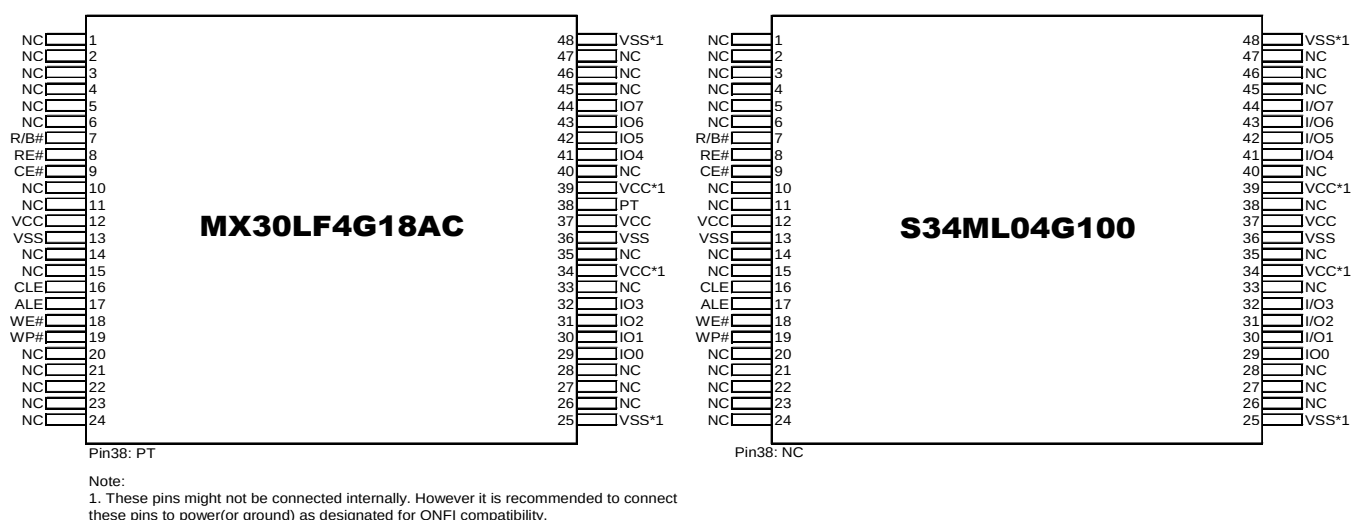


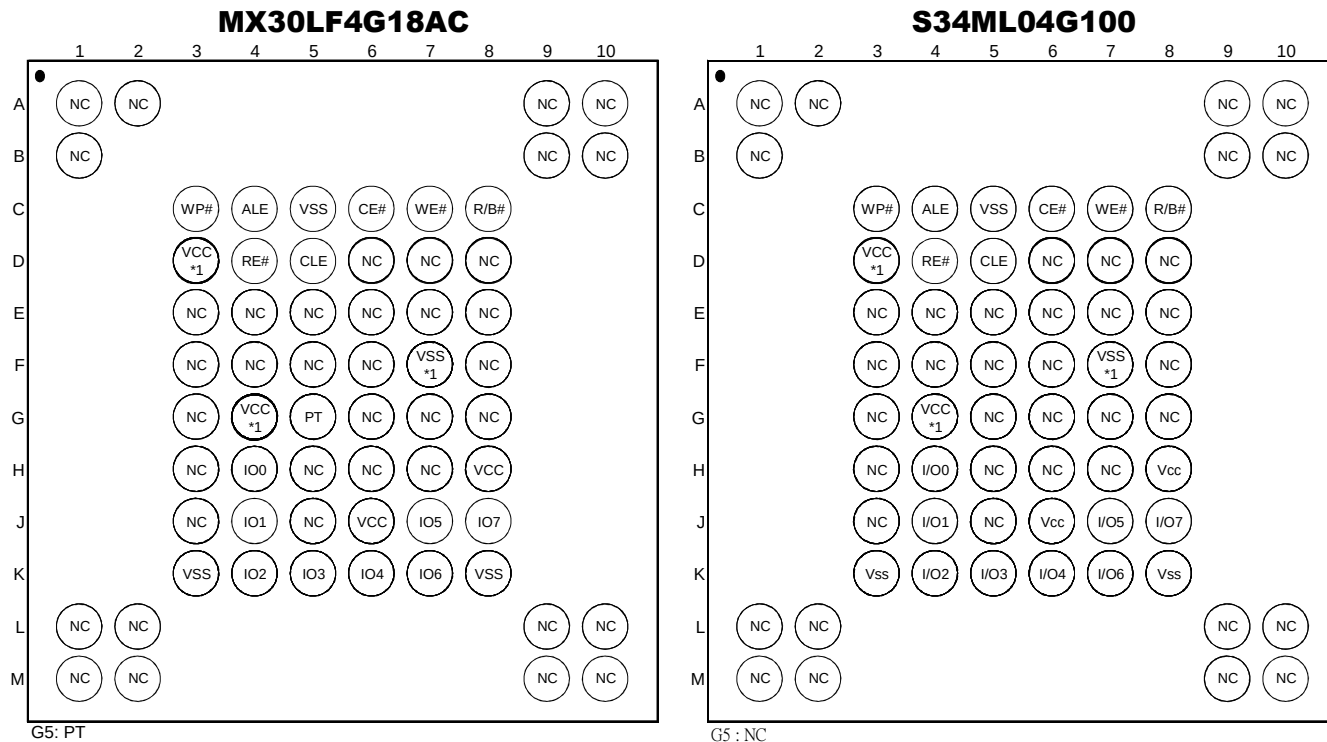
Table 5-1: 48-TSOP Package Pin Definition

Brand	Macronix	Spansion	Note
Part Name	MX30LF4G18AC-TI	S34ML04G100	
#38 pin	PT^{*1}	NC^{*1}	If no connect, both pin functions are the same

Note: The PT pin can be left unconnected as it has a weak internal pull-down to disable the protection feature..
 Please refer to the datasheet for more details. NC = No Connect.

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Figure 5-2: 63-VFBGA (9x11mm) Package and Pin Layout Comparison



Note:

1. These pins might not be connected internally. However it is recommended to connect these pins to power(or ground) as designated for ONFI compatibility.

Table 5-2: 63-VFBGA Package Ball Definition

Brand	Macronix	Spansion	Note
Part Name	MX30LF4G18AC-XKI	S34ML04G100	
#G5 ball	PT ^{*1}	NC ^{*1}	If no connect, both pin functions are the same

Note: The PT pin can be left unconnected as it has a weak internal pull-down to disable the protection feature.. Please refer to the datasheet for more details. NC = No Connect.

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6. Command Set

Basic command sets (Read/Program/Erase commands) and status checking methods are similar.

Additionally, Macronix supports a Unique ID Read, Set/Get Feature and Block Protection Status Read function and Spansion® does not (Table 6-1).

Table 6-1: Command Table

Command	Macronix MX30LF4G18AC		Spansion S34ML04G100	
	1st Cycle	2nd Cycle	1st Cycle	2nd Cycle
Random Data Input	85h	-	85h	-
Random Data Output	05h	E0h	05h	E0h
Cache Read Begin	00h	31h	00h	31h
Cache Read Sequential	31h		31h	
Read Mode	00h	30h	00h	30h
Cache Read End	3Fh	-	3Fh	-
Copy Back Read	-	-	00h	35h
Read ID	90h	-	90h	-
Reset	FFh	-	FFh	-
Page Program	80h	10h	80h	10h
Cache Program	80h	15h	80h	15h
Copy Back Program	-	-	85h	10h
Block Erase	60h	D0h	60h	D0h
Read Status	70h	-	70h	-
Read Status Enhanced	78h	-	78h	-
Read Parameter Pg.	ECh	-	ECh	-
Unique ID Read	EDh		-	
Set Feature	EFh		-	
Get Feature	EEh		-	
Block Protection Status Read	7Ah		-	

Table 6-2: Two-Plane Command Table

Command	Macronix MX30LF4G18AC				Spansion S34ML04G100			
	1st Cycle	2nd Cycle	3rd Cycle	4th Cycle	1st Cycle	2nd Cycle	3rd Cycle	4th Cycle
ONFI 2 Plane Program	80h	11h	80h	10h	80h	11h	80h	10h
ONFI 2 Plane Cache Program	80h	11h	80h	15h	80h	11h	80h	15h
ONFI 2 Plane Copy Back Program	-	-	-	-	85h	11h	85h	10h
ONFI 2 Plane Block Erase	60h	D1h	60h	D0h	60h	D1h	60h	D0h

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6-2 Status Register

When a flash Read/Program/Erase operation is in progress, either the “Ready/Busy# Pin Checking” or “Status Output Checking” method may be used to monitor the operation. Both are standard NAND flash algorithms and can be used for both devices. Table 6-3 shows that Status Output content provided by the Read Status command (70h) is compatible. Table 6-4 shows that Two-plane Operation Status output provided by the Enhance Read Status command (78h) is compatible.

Table 6-3: Status Output

Status Output	Macronix MX30LF4G18AC	Spansion S34ML04G100
SR[0]	PGM/ERS status: Pass/Fail	PGM/ERS status: Pass/Fail
SR[1]	Cache Program status: Pass/Fail	Cache Program status: Pass/Fail
SR[2]	Reserved	Reserved
SR[3]	Reserved	Reserved
SR[4]	Reserved	Reserved
SR[5]	PGM/ERS/Read internal controller: Ready/Busy	PGM/ERS/Read internal controller: Ready/Busy
SR[6]	PGM/ERS/Read status: Ready/Busy	PGM/ERS/Read status: Ready/Busy
SR[7]	Write Protect	Write Protect

Table 6-4: Two-Plane Status Output

Status Output	Macronix MX30LF4G18AC	Spansion S34ML04G100
SR[0]	Selected Plane PGM/ERS status: Pass/Fail	Selected Plane PGM/ERS status: Pass/Fail
SR[1]	Selected Plane Cache Program status: Pass/Fail	Selected Plane Cache Program status: Pass/Fail
SR[2]	Reserved	Reserved
SR[3]	Reserved	Reserved
SR[4]	Reserved	Reserved
SR[5]	PGM/ERS/Read internal controller: Ready/Busy	PGM/ERS/Read internal controller: Ready/Busy
SR[6]	PGM/ERS/Read status: Ready/Busy	PGM/ERS/Read status: Ready/Busy
SR[7]	Write Protect	Write Protect

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7. Read ID Command

The ID codes of the Macronix MX30LF4G18AC and S34ML04G100 differ in the manufacturer ID and in the last byte (Table 7-1).

Table 7-1: Manufacturer and Device IDs

ID code		Macronix MX30LF4G18AC	Spansion S34ML04G100
Value		C2h/DCh/90h/95h/56h	01h/DCh/90h/95h/54h
1 st Byte		Manufacturer Code	Manufacturer Code
2 nd Byte		Device Identifier	Device Identifier
3 rd Byte	IO1, IO0	Number of Die per Chip Enable	Number of Die per Chip Enable
	IO3, IO2	Cell Structure	Cell Structure
	IO5, IO4	Number of Simultaneously Programmed Pages	Number of Simultaneously Programmed Pages
	IO6	Interleaved Programming Between Multiple Chips	Interleaved Programming Between Multiple Chips
	IO7	Cache Program	Cache Program
4 th Byte	IO1, IO0	Page Size (exclude Spare Area)	Page Size (exclude Spare Area)
	IO2	Size of Spare Area (Byte per 512Byte)	Size of Spare Area (Byte per 512Byte)
	IO7, IO3	Sequential Read Cycle Time (tRC)	Serial Access Time (tRC)
	IO5, IO4	Block Size (exclude Spare Area)	Block Size (exclude Spare Area)
	IO6	Organization	Organization
5 th Byte	IO0, IO1	ECC Level Requirement	Reserved
	IO2, IO3	Number of Plane per CE	Number of Plane per CE
	IO4~IO6	Plane Size	Plane Size
	IO7	Reserved	Reserved

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8. Power-Up Timing

Macronix and Spansion® power-up sequences are similar, but the timing is slightly different. Although both devices use 2.7V (VCC min.) as the start point, measurement items are different. Check the system timing to determine if adjustments are needed.

Table 8-1: Power-Up Timing

H/W Timing Characteristic	Macronix MX30LF4G18AC	Spansion S34ML04G100
Vcc (min.) to WE# low	1ms (max.)	N/A
Vcc (min.) to R/B# high	N/A	5ms (max.)
Vcc (min.) to R/B# low	10us (max.)	100us (max.)

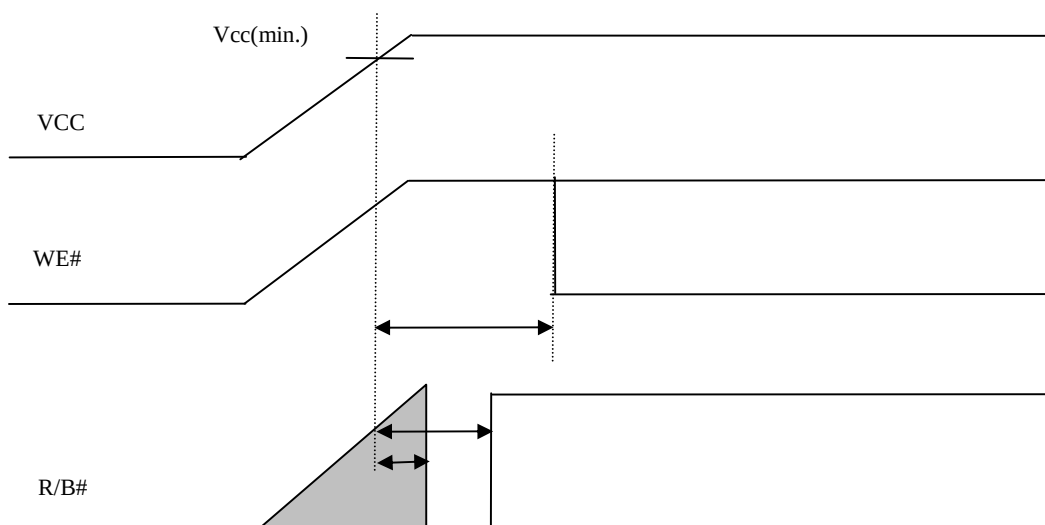


Figure 8-1: Power-Up Timing

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9. Summary

Macronix MX30LF4G18AC and Spansion® S34ML04G100 NAND have similar features and pinouts. Because basic Read/Program/Erase commands as well as block, page, and spare area sizes are the same, device migration may require minimal or no firmware modifications to accommodate differences in ECC requirements.

10. Reference

Table 10-1 shows the datasheet versions used for comparison in this application note. For the most current, detailed Macronix specification, please refer to the Macronix Website at <http://www.macronix.com>

Table 10-1: Datasheet Version

Datasheet	Location	Date Issue	Revision
MX30LF4G18AC	Website	Oct. 23, 2014	Rev. 1.0
S34ML04G100	Website	Feb. 10, 2014	Rev. 17

Note: Macronix data sheet is subject to change without notice.

11. Appendix

Cross Reference Table 11-1 shows basic part number and package information for the Macronix MX30LF4G18AC and Spansion® S34ML04G100 product families.

Table 11-1: Part Number Cross Reference

Density	Macronix Part No.	Spansion Part No.	Package	Dimension
4Gb	MX30LF4G18AC-TI	S34ML04G100TFI00	48-TSOP	12x20mm
	MX30LF4G18AC-XKI	S34ML04G100BHI00	63-VFBGA	9x11x1.0mm

12. Revision History

Revision	Description	Date
1.0	Initial Release	Dec. 14, 2014



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APPLICATION NOTE

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